

**In the Specification:**

**Please amend paragraph [0020] as follows:**

[0020] The ceramic layer 2 is for example made of aluminum oxide,  $\text{Al}_2\text{O}_3$ ,  $\text{Al}_2\text{O}_3$ , or aluminum nitride (AlN) Other ceramics, for example  $\text{Si}_3\text{N}_4$ , SiC, BeO,  $\text{TiO}_2$ ,  $\text{ZrO}_2$  or  $\text{Al}_2\text{O}_3$ ,  $\text{Al}_2\text{O}_3$  containing  $\text{ZrO}_2$ , for example between 5-30 percent by weight, and mullite ( $3\text{Al}_2\text{O}_3$ ,  $\text{Al}_2\text{O}_3$  x 2 silicon oxide) are also conceivable.

**Please amend paragraph [0023] as follows:**

[0023] A special feature of the method according to the invention is the production of the separating or break-off lines 6 and 7 in the ceramic layer 2. This special processing step, which is also referred to as thermal processing, is depicted in Figures 2 - 4 and consists essentially in the fact that the ceramic layer 2 is progressively heated and then shock-cooled partially and linearly, thus producing - along the entire processing line or separating and break-off line - a controlled weakening of material or fracture between the top side and bottom side of the ceramic layer 2 ~~within 2~~ within the ceramic layer through mechanical tensions, which occur during heating and subsequent cooling, as shown at 8 in Figure 4.